

# DUAL SURFACE MOUNT SCHOTTKY BARRIER DIODE

#### Features

- Low Forward Voltage Drop
- Common Cathode Configuration
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)

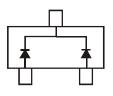
#### **Mechanical Data**

- Case: SC59
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)

SC59



Top View



**Device Schematic** 

## Ordering Information (Note 5)

Case	Packaging
SC59	3000/Tape & Reel
	0.070

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

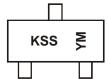
See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>

4. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to

Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.

5. For Packaging Details, go to our website at http://www.diodes.com.

#### **Marking Information**



KSS = Product Type Marking Code YM = Date Code Marking Y =Year (ex: N = 2002) M = Month (ex: 9 = September)

#### Date Code Key

Year	2002	2003	2004		2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	Ν	Р	R		V	W	Х	Y	Z	А	В	С	D	E
Month	Jan	Feb	Ма	r A	Apr	Мау	Jun	Jul	Aug	Sep	o (	Oct	Nov	Dec
Code	1	2	3		4	5	6	7	8	9		0	Ν	D



# Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Forward Continuous Current (Note 6)	I <sub>FM</sub>	0.4	А
Non-Repetitive Peak Forward Surge Current @ t = 8.3ms	IFSM	2	А
Repetitive peak Forward Current	I <sub>FRM</sub>	500	mA

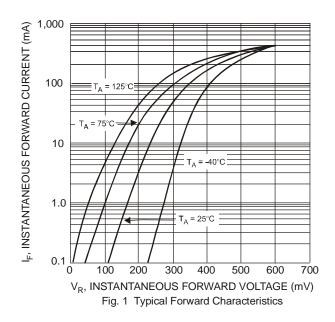
### **Thermal Characteristics**

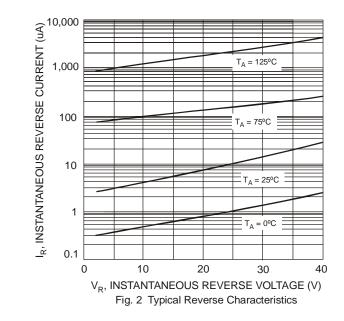
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	400	mW
Operating Temperature Range	T <sub>OP</sub>	-30 to +85	°C
Junction Temperature Range	TJ	-30 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-40 to +125	°C

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	40	—	_	V	I <sub>R</sub> = 500μA
Forward Voltage	VF	_	_	300		$I_F = 10 \text{mA}$
Forward Voltage	٧F		—	500		I <sub>F</sub> = 200mA
Leakage Current (Note 7)	I <sub>R</sub>	—	—	70	μA	$V_R = 25V$
Total Capacitance	CT	_	_	100	pF	$V_{R} = 0V, f = 1.0MHz$

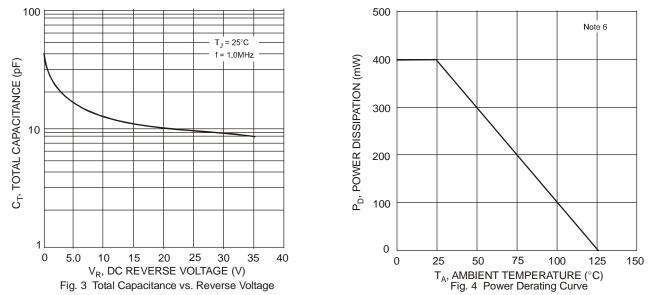
Notes: 6. Mounted on FR4 PC Board with recommended pad layout which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 7. Short duration pulse test used to minimize self-heating effect.



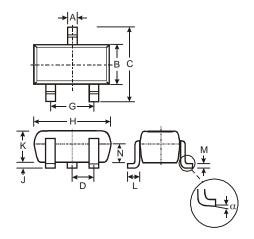




## SDM20E40C

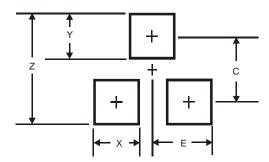


## Package Outline Dimensions



SC59							
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
С	2.70 3.00		2.80				
D	-	-	0.95				
G	-	-	1.90				
Н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
Κ	1.00	1.30	1.10				
L	0.35	0.55	0.40				
Μ	0.10	0.20	0.15				
Ν	0.70	0.80	0.75				
α	0°	8°	-				
All Dimensions in mm							

# Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.4
Х	0.8
Y	1.0
С	2.4
E	1.35



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